



## Gallium Nitride 50V, 450W, 4.6-5GHz RF Power Transistor

### Description

The STCV50450BY4V is a 450-watt, internally matched GaN HEMT, designed for 5G cellular applications with frequencies from 4.6-5.0GHz, **enabled by wide band VBW capability to support IBW  $\geq$  200MHz.**

It can be configured as asymmetrical Doherty for 5G application, delivering 55W average power, according to normal 9dB back off.

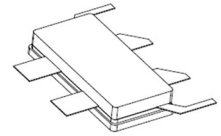
- Typical Doherty Pulsed CW and 1C W--CDMA Characterization Performance:

(1) Pulsed condition: 100us and 10% (2) 1C WCDMA; Signal PAR = 10 dB @ 0.01% Probability on CCDF.

VDS= 50V, IDQ-main=230 mA Vgs-main=-3.0V. Vgs-peak=-6.5V

Asymmetrical Doherty amplifier within N79 5G band and S band power amplifier

**STCV50450BY4V**



Freq (GHz)	Pulse CW Signal <sup>(1)</sup>			P <sub>avg</sub> =47.5dBm WCDMA Signal <sup>(2)</sup>		
	GainP1 (dB)	P3 (dBm)	P3 (W)	Gp (dB)	$\eta_D$ (%)	ACPR <sub>5M</sub> (dBc)
4.6	9.56	56.79	478	9.95	39.96	-33.33
4.7	9.95	56.80	478	10.31	41.78	-36.84
4.8	10.56	56.59	456	10.39	41.84	-36.44
4.9	10.36	56.45	442	10.18	41.37	-34.74
5.0	9.90	56.35	431	9.57	39.53	-32.38

### Important Note: Proper Biasing Sequence for GaN HEMT Transistors

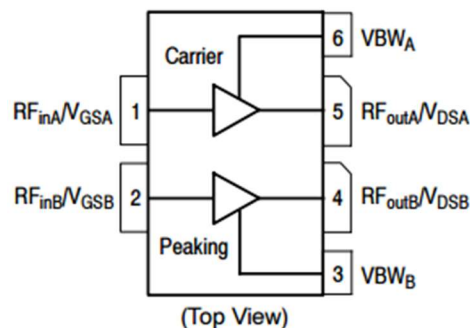
#### Turning the device ON

1. Set VGS to the pinch-off (VP) voltage, typically -5 V
2. Turn on VDS to nominal supply voltage
3. Increase VGS until IDS current is attained
4. Apply RF input power to desired level

#### Turning the device OFF

1. Turn RF power off
2. Reduce VGS down to VP, typically -5 V
3. Reduce VDS down to 0 V
4. Turn off VGS

Figure 1: Pin Connection definition





**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain—Source Voltage	$V_{DSS}$	+200	Vdc
Gate—Source Voltage	$V_{GS}$	-8 to +0.5	Vdc
Operating Voltage	$V_{DD}$	55	Vdc
Maximum gate current	$I_{gs}$	55.6	mA
Storage Temperature Range	$T_{stg}$	-65 to +150	°C
Case Operating Temperature	$T_c$	+150	°C
Operating Junction Temperature	$T_J$	+225	°C

**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA $T_c=85^\circ\text{C}$ , $P_{out}=90\text{W}$ , 4.9GHz Doherty application board	$R_{\theta JC}$	1.3	°C /W

**Table 3. Electrical Characteristics (TA = 25°C unless otherwise noted)**

**DC Characteristics (main path, measured on wafer prior to packaging)**

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=-8\text{V}$ ; $I_{DS}=21.6\text{mA}$	$V_{DSS}$		200		V
Gate Threshold Voltage	$V_{DS}=10\text{V}$ , $I_D=21.6\text{mA}$	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	$V_{DS}=50\text{V}$ , $I_{DS}=280\text{mA}$ , Measured in Functional Test	$V_{GS(Q)}$		-3.07		V

**DC Characteristics (peak path, measured on wafer prior to packaging)**

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=-8\text{V}$ ; $I_{DS}=34\text{mA}$	$V_{DSS}$		200		V
Gate Threshold Voltage	$V_{DS}=10\text{V}$ , $I_D=34\text{mA}$	$V_{GS(th)}$	-4		-2	V
Gate Quiescent Voltage	$V_{DS}=50\text{V}$ , $I_{DS}=280\text{mA}$ , Measured in Functional Test	$V_{GS(Q)}$		-3.3		V

**Ruggedness Characteristics**

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Load mismatch capability	4.9GHz, $P_{out}=55\text{W}$ WCDMA 1 Carrier in Doherty circuit All phase, No device damages	VSWR		10:1		



### Typical performance 4600-5000MHz Doherty

Figure 2: Intermodulation Distortion Products versus Two-Tone Spacing

V<sub>dd</sub>=50V, P<sub>out</sub>=47.5dBm, Center Frequency=4.9GHz

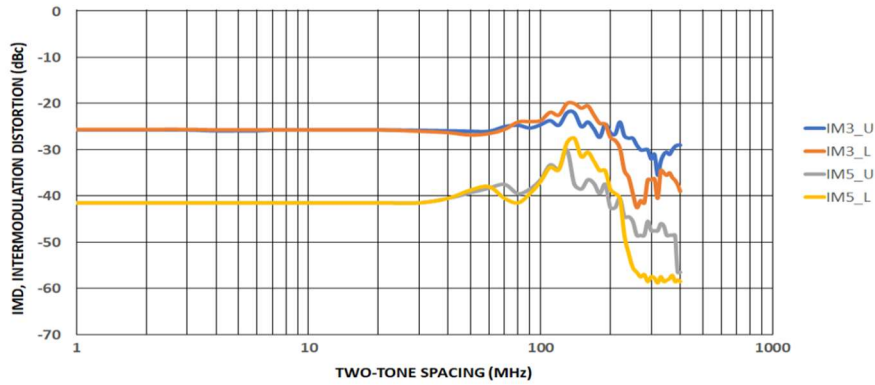


Figure 3: Efficiency and power gain as function of P<sub>out</sub> (4.6-5GHz Doherty)

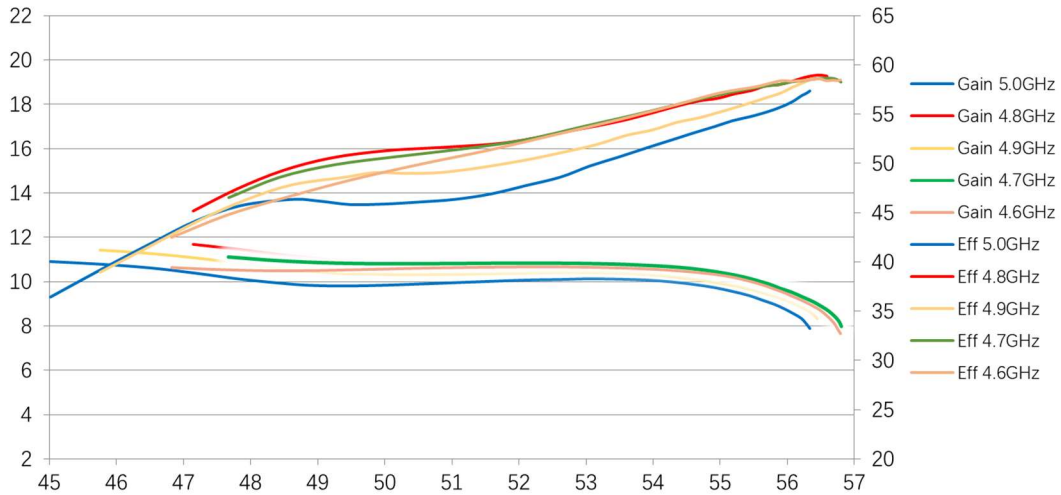
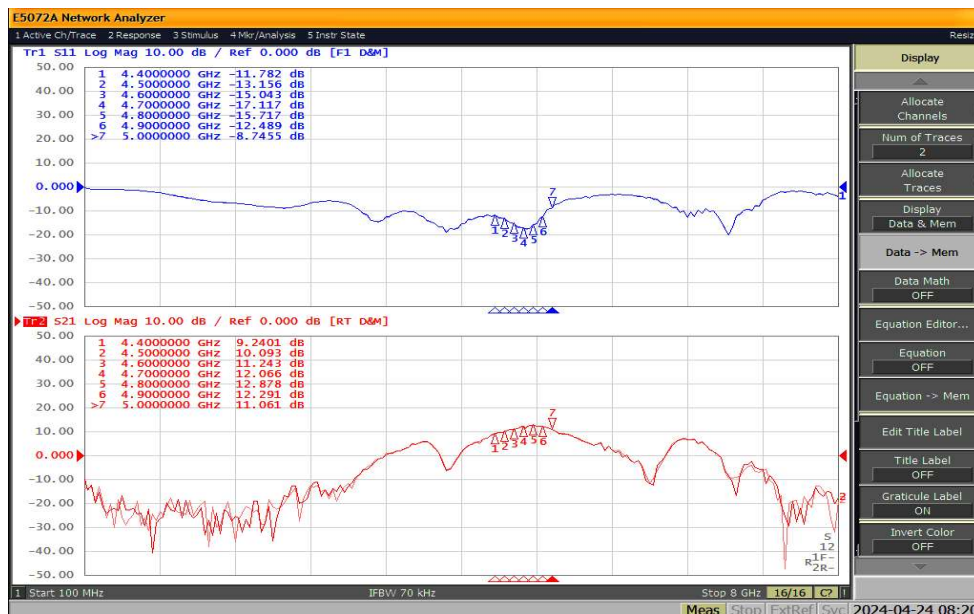
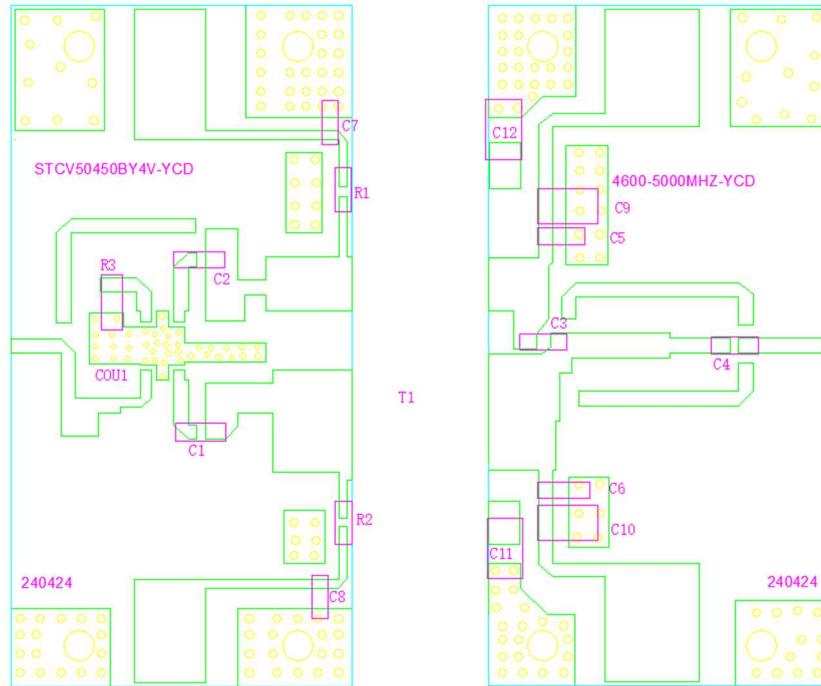


Figure 4: Network analyzer output, S11 and S21 (4.6-5GHz Doherty)



**Figure 5: Picture of application board Doherty circuit for 4.6-5GHz**

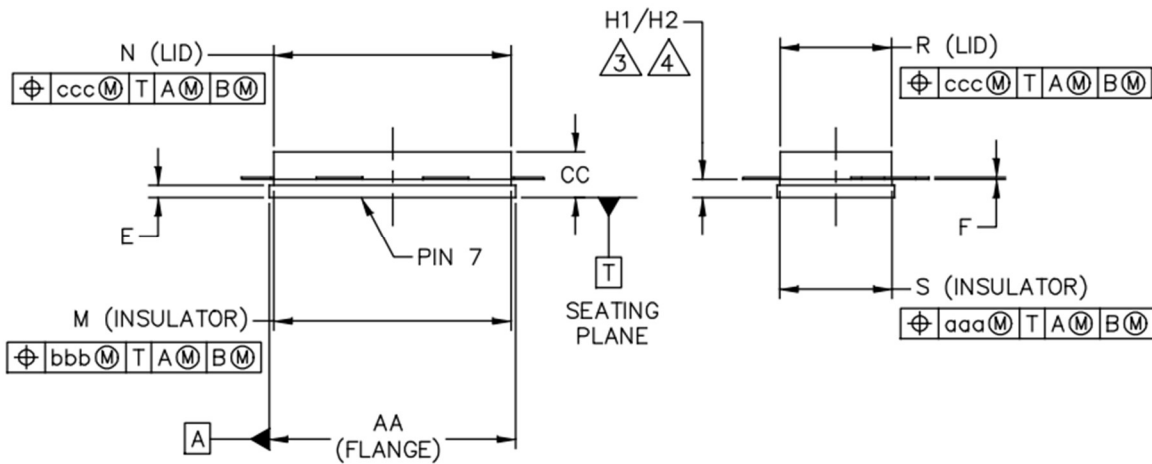
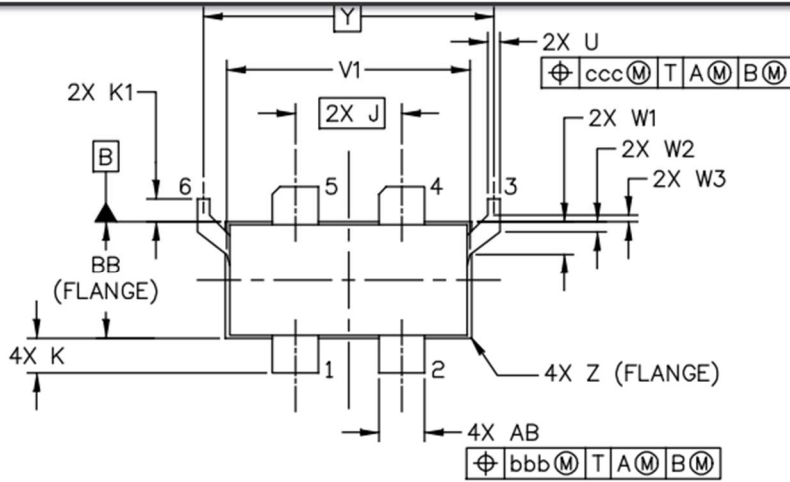


**Table 4. Bill of materials of application board (PCB layout upon request, RO4350B 20mils)**

Part	Quantity	Description	Part Number	Supplier
C1,C2,C4,C5,C6, C7,C8	7	3.9pF High Q Capacitor	251SHS3R9BSE	TEMEX
C3	1	0.9pF High Q Capacitor	251SHS0R9BSE	TEMEX
C9,C10,C11,C12	4	10uF MLCC	GRM32EC72A106M E05	Murata
R1,R2	2	10 Ω Power Resistor	ESR03EZPF100	ROHM
R3	1	51 Ω Power Resistor	S1206N	RN2
COU1	1	3 dB Hybrid	X3C45F1-03S	Anaren
T1	1	450W GaN Dual Transistor	STCV50450BY4V	Innogrations



**Earless Flanged Ceramic Package; 6 leads- BY4V**



DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
AA	.805	.815	20.45	20.70	R	.365	.375	9.27	9.53
BB	.380	.390	9.65	9.91	S	.365	.375	9.27	9.53
CC	.125	.170	3.18	4.32	U	.035	.045	0.89	1.14
E	.035	.045	0.89	1.14	V1	.795	.805	20.19	20.45
F	.004	.007	0.10	0.18	W1	.0975	.1175	2.48	2.98
H1	.057	.067	1.45	1.70	W2	.0225	.0425	0.57	1.08
H2	.054	.070	1.37	1.78	W3	.0125	.0325	0.32	0.83
J	.350 BSC		8.89 BSC		Y	.956 BSC		24.28 BSC	
K	.0995	.1295	2.53	3.29	Z	R.000	R.040	R0.00	R1.02
K1	.070	.090	1.78	2.29	AB	.145	.155	3.68	3.94
M	.774	.786	19.66	19.96	aaa	.005		0.13	
N	.772	.788	19.61	20.02	bbb	.010		0.25	
					ccc	.015		0.38	



## Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/5/31	V2.0	Preliminary Datasheet Creation ,according to latest application result
2024/4/25	V2.1	Modify application data according to improvement

Application data based on LWH-23-12/24-14

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